ASSOCIATION CONNECTINI ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				nder both This d	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.								
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ials and M	fg Informa	tion	
upplier Inform									,			<u> </u>		
Company name*			Company unique ID			U	Unique ID Authority				Response Date*			
nsemi											2025-05-14			
Contact Name			Title - Contact			P	Phone - Contact*				Email - Contact*			
Product-Env-Stewa	ards		Product Enviro Compliance			N	NA				Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative			P	Phone - Representative*				Email - Representative*			
Product-Env-Stewa	ards	Product Enviro Compliance			N	NA				Product-Env-Stewards@onsemi.com				
Requeste	Requester Item Number Mfr Item		m Number Mfr Item Name			]	Effective Date	Date Version Manufacturing Site			Weight*	UOM	Unit Type	
		NCV8164 G	4AML300TC	LDO 300 mA AD High PSRR in DF	3V0, Ultra-Low Nois NW8	se and	2025-05-14		7	ГН6		23.83	mg	Each
Ianufacturing	Proccess Information	1												
Terminal Plating / Grid Array Material Terminal Plating / Grid Array Material			erminal Base Alloy J-STD-020 MSL I		J-STD-020 MSL Ratin	ıg	Peak Process Body Temperature Max Time at P		re Max Time at Peak	ak Temperature Number of Reflow Cycles				
Matte Tin (Sn) - annealed		C	CU Alloy 1		1		260	0 C 30		secon	ds 3			
omments														
vel 1 - maximum ti	ime at peak temperature d	luring sol	dering is 10-3	0 seconds						·			·	
or more informatio	on regarding material com	position p	please refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct one bents it is form. Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.45	mg	Supplier	Silicon (Si)	7440-21-3		0.45	mg
Die Attach	0.15	mg	Supplier	Silver (Ag)	7440-22-4		0.1275	mg
			Supplier	Acrylic resins	Proprietary Data		0.0225	mg
Lead Frame	9.89	mg	Supplier	Tin (Sn)	7440-31-5		0.0247	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0218	mg
			Supplier	Chromium (Cr)	7440-47-3		0.0247	mg
			Supplier	Copper (Cu)	7440-50-8		9.8188	mg
Lead Frame plating	0.04	mg	Supplier	Silver (Ag)	7440-22-4		0.04	mg
Mold Compound-Black	12.2	mg		Epoxy resin	proprietary data		0.61	mg
			Supplier	Phenolic Resin	Proprietary Data		0.2806	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.61	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0488	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.2806	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		10.37	mg
Plating	0.75	mg	Supplier	Tin (Sn)	7440-31-5		0.75	mg
Wire Bond - Au	0.35	mg	Supplier	Gold (Au)	7440-57-5		0.35	mg